Anirudha Karati, Sanyukta Ghosh, Ramesh Chandra Mallik, Rajashekhara Shabadi, B.S. Murty, and U.V. Varadaraju

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Sn-doped $\text{TiFe}_{0.5}\text{Ni}_{0.5}\text{Sb}_{1-x}\text{Sn}_x$ (x = 0, 0.05, 0.1, 0.2) were synthesized by vacuum arc melting (VAM). In addition to the half-Heusler phase, secondary phases of Fe–Sb-rich compound and Ti-rich compounds were obtained after VAM. The alloys were then subjected to ball milling for 1 h and 5 h. Ball milling for 1 h led to microcrystalline grains, while that for 5 h led to nanocrystalline grains. Ball milling followed by spark plasma sintering (SPS) at 1173 K led to significant reduction in size of secondary phases in the microstructure. The undoped sample exhibited a ZT of 0.008 at 873 K for both 1h and 5h BM-SPS samples.

Keywords	intermetallic	alloys,	powder	metallurgy,
	semiconductors, sintering			

1. Introduction

The ever-increasing demand of fossil fuels coupled with its fast depletion has channeled research interests towards clean, renewable and earth abundant resources. Among the many readily available alternative energy sources, thermoelectricity, which involves heat recovery to produce electricity, has been a topic of intense research over the last few decades. Thermoelectric materials that are used in devices have advantage over conventional heat engines owing to its lack of moving parts, less impact to environment, noiseless operation and high reliability (Ref 1–3). The efficiency of thermoelectric materials is denoted by the dimensionless figure of merit (ZT), which can be expressed as:

$$ZT = \frac{S^{2\sigma}}{\kappa}T$$

where S represents the Seebeck coefficient, σ is the electrical conductivity, κ is the thermal conductivity comprising of κ_e

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Anirudha Karati and U.V. Varadaraju, Department of Chemistry, Indian Institute of Technology Madras, Chennai, India; Sanyukta Ghosh and Ramesh Chandra Mallik, Thermoelectric Materials and Devices Laboratory, Department of Physics, Indian Institute of Science, Bangalore, India; Rajashekhara Shabadi, Faculty of Science and Technology, UMET, University of Lille, Villeneuve-d'Ascq, France; B.S. Murty, Department of Chemistry, Indian Institute of Technology Madras, Chennai, India; Department of Metallurgical and Materials Engineering, Indian Institute of Technology Madras, Chennai, India; and Indian Institute of Technology Hyderabad, Kandi, India. Contact e-mail: murty@iitm.ac.in.

(electronic) and κ_1 (lattice), and T is the absolute temperature. For a material to exhibit good thermoelectric property, it should possess high S, high σ and low κ to obtain a high thermoelectric figure of merit (ZT). However, high σ increases the κ_e and thus optimization of both σ and κ_1 is required to enhance the overall σ/κ ratio (Ref 4). Thermoelectric materials operate in different temperature regimes, and thus there exist different classes of materials such as chalcogenides (Ref 5), skutterudites (Ref 6) and Zintl phase compounds (Ref 7) operating in low- (300-500 K), mid- (500-800 K) and hightemperature (800-1100 K) regimes. One such class of compounds that has demonstrated high ZT in mid- to hightemperature regimes are half-Heusler alloys. Half-Heusler alloys have gained prominence owing to their good mechanical and thermal robustness (Ref 8), excellent electronic properties due to narrow band gap of ~1eV, high Seebeck coefficient and high electrical conductivity. Additionally, it is made of elements that are less toxic and more earth abundant (Ref 9).

Half-Heusler alloys adopt the MgAgAs type of structure crystallizing adopting the space group $F\overline{4}3m$ (Ref 10). The structure comprises three interpenetrating fcc sub-lattices. Compositions in half-Heusler alloys that have a valence electron count of 18 are found to have the Fermi energy level (E_f) to be present in the center of the band structure. Such systems tend to be semiconducting and hence are suitable candidates for thermoelectric applications (Ref 11). TiNiSn and TiCoSb are the two well-studied systems among half-Heusler alloys (Ref 9). TiCoSb is an intrinsic n-type semiconductor. It has high room-temperature Seebeck coefficient and electrical resistivity values of $-265 \ \mu\text{V/K}$ and $4.5 \times 10^{-2} \ \Omega\text{cm}$, respectively (Ref 12). However, it has a very high thermal conductivity of 24 Wm^{-1} K⁻¹ at 373 K (Ref 13). This high thermal conductivity serves to be one of the biggest bottlenecks in the application of half-Heulser alloys as thermoelectric materials. Methods like nanostructuring to introduce grain boundary scattering (Ref 14), in situ formation of second phase (Ref 15), ex situ addition of second phase (Ref 16) and point defects generated due to solid solution formation (Ref 17) are some of the strategies that have been generally employed to reduce κ by reducing the lattice part of thermal conductivity (κ_1)in half-Heusler alloys. Kim *et al.* reported a much reduced κ_1 of 2.4

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 $\rm Wm^{-1} K^{-1}$ for TiCoSb synthesized by mechanical alloying followed by spark plasma sintering (Ref 18). Ball milling of cast ingot followed by powder consolidation has led to increased ZT due to grain boundary scattering in $\rm Hf_{0.8}Ti_{0.2}$. CoSb_{0.8}Sn_{0.2} (Ref 19). It has been further shown that isostructural substitution of Ti in the Zr center leads to improved thermoelectric properties due to increased effective mass and point defect scattering in $\rm Zr_{0.5}Ti_{0.5}CoSb_{0.7}Sn_{0.3}$ (Ref 20).

Balke et al. reported the synthesis of a new half-Heusler alloy, TiFe0.5Ni0.5Sb. It was obtained by replacing Co with Fe having an electron less than Co and Ni having an electron greater than Co (Ref 21). The band structure diagrams of TiFeSb showed the E_f (Fermi level) to be present in the valence band and the material was found to behave like a Curie-Weiss paramagnet (Ref 22). On the other hand, in the case of the band structure of TiNiSb, the Ef was found to be in the conduction band and the material behaved like a Pauli paramagnet (Ref 22). The band structure of TiFe_{0.5}Ni_{0.5}Sb shows the presence of Fermi energy level at the center of the valence and conduction bands as per theoretical calculations (Ref 23, 24). However, because of compositional variations that are commonly encountered during synthesis of half-Heusler compounds, the Fermi level shifts near to conduction band and TiFe0.5Ni0.5Sb ends up exhibiting n-type semiconducting property (Ref 21). The substitution of Co with Fe and Ni leads to increased electrical conductivity and reduced thermal conductivity in the system when measured at 300 K. This is because while the band gap of TiFe_{0.5}Ni_{0.5}Sb is 0.8 eV (Ref 21), the band gap of TiCoSb is 0.95 eV (Ref 22). The reduction in κ is attributed to magnetic scattering of phonons by Fe ions, presence of impurity phases and mass fluctuation effects (Ref 21).

For any thermoelectric device to work, the presence of a ptype and n-type legs having similar thermoelectric and mechanical properties is important. TiCoSb and TiFe0.5Ni0.5Sb exhibit n-type semiconducting property. The introduction of Sn in the Sb center in TiCoSb has led to the generation of p-type thermoelectric materials because of the introduction of holes in the system. This is owing to Sn having an electron less than Sb (Ref 18, 25). Furthermore, reports have claimed for TiCoSb to exhibit higher ZT at higher temperature (Ref 21). At present, the high-temperature thermoelectric properties of TiFe_{0.5-} Ni_{0.5}Sb have not been reported in the literature. In the present work, synthesis of $TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x(x = 0, 0.05, 0.1, 0.2)$ has been carried out by two routes to see the effect of processing routes on the thermoelectric properties. The alloys are first made by vacuum arc melting followed by (1) Ball Milling for 1 h and spark plasma sintering (1h BM-SPS) and (2) ball milling for 5 h and spark plasma sintering (5h BM-SPS). Subsequently, the thermoelectric properties are measured up to 850 K that gives us an idea about the effects of grain size on the thermoelectric property of these alloys.

2. Experimental Section

Ti, Fe, Ni, Sn and Sb powders were weighed in stochiometric ratio and ground, and a green compact was made by applying a uniaxial load of 300 MPa to make a 20-mm diameter pellet. Sb shots were weighed and taken separately. To account for the weight loss of Sb, 5% extra Sb was added. The Sb shots were placed on the copper hearth in the arc melting furnace followed by the pellet (comprising of Ti, Fe, Ni and Sn) on top of it. The arc melting chamber was pre-evacuated up to 8×10^{-6} m-bar pressure, and subsequently high-purity Ar gas was purged into it till it reached 1×10^{-3} m-bar pressure. This process was carried out twice. Ti shots, used as getter material, were melted to trap the excess oxygen within the chamber. The loss of Sb, that is generally encountered with owing to its high vapor pressure, was minimized by maintaining a low current throughout the melting process. The buttons were flipped and re-melted 4 times to ensure homogeneity in the sample. The samples were subsequently hand-crushed into powder using a mortar and pestle.

The crushed alloys were made nanocrystalline using Fritsch pulverisette-5 ball mill. The hand-crushed powder was loaded into an 80-mL tungsten carbide (WC) vials containing WC balls. The ball-to-powder weight ratio was kept as 10:1. Toluene was used as process control agent (PCA), and speed of milling was kept to 300 rpm. The cast alloys were milled for 1 h to make microcrystalline powder and for 5 h to make nanocrystalline alloys. In order to consolidate the powder samples, spark plasma sintering (SPS) was carried out using Dr. Sinter Plus. Sintering was carried out at 1173 K at a heating rate of 100 K/min and held at that temperature for 5 minutes. For the 1-h milled samples, a pressure of 60 MPa was applied, while a pressure of 50 MPa was applied for the 5-h milled samples. All the samples exhibited relative density greater than 95 % as determined by Archimedes method. The as-cast alloys were polished to obtain a flat surface and XRD analysis of the same was carried out. XRD analysis was carried out using X'Pert Pro PanAlytical equipment with Cu-Ka as X-ray source with a wavelength of 1.5406 Å. The scanning was carried out in the range of 20-90 with a scan rate of 0.02 s⁻¹ and a time per step of 20 s.

The single-peak profile analysis using pseudo-Voigt function was used for crystallite size analysis from XRD patterns. Rietveld refinement was carried out using FULLPROF software. The phase changes were observed using a SETARAM LabSys evo differential thermal analyzer (DTA) from RT to 600 °C. The compositions of the alloys were estimated by the mapping mode using an energy dispersive spectroscopy (EDS) unit attached with an Inspect-F field emission scanning electron microscope (FE-SEM) and Quanta 400 (FE-SEM). The Seebeck coefficient (S) and electrical conductivity (σ) were measured by the differential method and four probe method, respectively, using Linseis LSR-3 from room temperature to 873 K. Thermal diffusivity measurements were investigated using laser flash technique in a Netzsch LFA-427.

3. Results and Discussion

3.1 Synthesis of Microcrystalline Alloys by Vacuum Arc Melting (VAM)

The XRD patterns of the as-cast alloys are depicted in Fig. 1. All the alloys exhibited peaks corresponding to the half-Heusler structure crystallizing in $F\overline{4}3m$ structure. No secondary phases were observed in x = 0, 0.05 and 0.1 alloys. However, peaks corresponding to full Heusler phase were observed in x = 0.2 alloy.

The lattice parameters of the cast alloys were measured using Nelson–Riley function and are as displayed in Table 1. It was observed that with increasing Sn concentration, there was a systematic increase in the lattice parameter value in the 1-h and 5-h BM alloys. This could be attributed to Sn having a higher atomic radius of 225 pm as compared to Sb (206 pm). The trend of increase in the lattice parameter is non-monotonic in the case of the SPS pellets. This could be due to the presence of secondary phases present in the SPS pellets. Figure 2 displays the low-magnification images of the cast alloys. In addition to the major grey phase, two other phases, namely black and white, are visible in the microstructure. The major grey phase was found to have a composition that is very similar to the bulk composition in all the samples. The black regions were found to be rich in Ti and exhibit porosities in all the alloys. The white region was found to be rich in Fe/Sb in the pristine sample. In the Sn-doped samples, the white region was found to be rich in Fe/Sb/Sn. The compositions of the individual phases of all the samples are depicted in Table 2.

3.2 Synthesis and Consolidation of Microcrystalline Alloys by Ball Milling and Spark Plasma Sintering (1h BM-SPS)

The as-cast alloys were hand-crushed and milled for 1 h to ensure increased homogeneity, and the XRD patterns are as displayed in Fig. 3(a). All the alloys exhibited peaks corresponding to the half-Heusler phase. Additional peaks indexed as full Heusler phase were observed in the 1-h BM powder of the 20% Sn-doped sample. The XRD pattern of the SPS pellets are displayed in Fig. 3(b). All the alloys exhibited single-phase half-Heulser structure without the presence of any secondary phases. The low-magnification images of the SPS pellets



Fig. 1 XRD patterns of as-cast TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x alloys

 Table 1
 Precision lattice parameter of the alloys based on processing conditions

confirmed better densification as compared to the cast alloys (Figure S1 of supplementary data). The cast alloys had porosities owing to the high vapor pressure of Sb and reduced boiling point in vacuum that can lead to its evaporation while vacuum arc melting (Ref 26). Furthermore, the size of white region is greatly reduced as there are no white regions observed at low-magnification images (Figure S1 of supplementary data). Thus, combination of BM and SPS significantly reduced the size of the secondary phases. This is because the as-cast alloys are brittle and could be made into fine powder after subjecting it to 1 h of ball milling. This brought about certain reduction in the size of the secondary phases too as they are also brittle in nature (Figure S1 of supplementary data). Additionally, the BM process also helps in dissolution of certain secondary phases as has been observed in our previous reports (Ref 27, 28).

As observed in the as-cast alloy, even the 1-h BM-SPS alloys showed a major grey phase along with two other phases, viz., white and black phases in their microstructure as observed in Fig. 4. The composition of the regions is displayed in Table 3. The bulk composition of all the alloys is similar to the nominal composition. The composition of the grey region is very similar to that of the overall composition. Although the composition of Fe and Ni should be similar, all the samples are found to be slightly richer in Ni. The black region is rich in Ti and corresponds to TiC which forms during the SPS process. Owing to the lower atomic number of Carbon, it could, however, not be estimated accurately. The white region was found to be rich in Fe and Sb in x = 0, 0.05 and 0.1 alloys. The white region in x = 0.2 alloy was found to be richer in Fe and Sn. Additionally, in all the samples (except x = 0.2 alloy) there was significant contribution of Ti owing to the white region being of finer size (<1 μ m) and interaction volume effect coming into play. The composition of x = 0.2 alloy in the white region was thus found to be slightly different from the other alloys.

3.3 Synthesis and Consolidation of Nanocrystalline Alloys by Ball Milling and Spark Plasma Sintering (5h BM-SPS)

The XRD patterns of the 5-h milled samples are shown in Fig. 5(a). Significant peak broadening was observed after 5 h of milling. The lattice parameter and crystallite size data of the milled alloys are displayed in Tables 1 and 4, respectively. All the alloys exhibited crystallite size below 100 nm. There was no lattice strain observed in all the samples, and hence the data of lattice strain are not included in the table (Table 5). Upon sintering of the milled powder, FeSb phase was also found in addition to the half-Heusler phase from XRD analysis as shown in Fig. 5(b). The Rietveld refinement was carried out on the 5-h milled alloys and is as shown in Figure S2 of supplementary data. The lattice parameter of the as-SPS pellets is shown in

		La	ttice parameter (in nm) b	ased on processing co	nditions
Alloy	Cast alloy	1h BM	1h BM-SPS	5h BM	5h BM-SPS
TiFe _{0.5} Ni _{0.5} Sb	0.59150	0.59131	0.5908	0.59133	0.59016
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	0.59154	0.59141	0.59105	0.59143	0.59041
$\begin{array}{l} TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}\\ TiFe_{0.5}Ni_{0.5}Sb_{0.8}Sn_{0.2} \end{array}$	0.59159 0.59191	0.59150 0.59186	0.59093 0.59099	0.59154 0.59167	0.59002 0.59060



Fig. 2 SEM BSE micrographs of as-cast alloys at low magnification showing the presence of 3 regions in (a) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.05}$, (b) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.05}$, (c) $TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}$ and (d) $TiFe_{0.5}Ni_{0.5}Sb_{0.8}Sn_{0.2}$. The labeled phases denote 1 (gray), 2 (white) and 3 (black) phases, respectively

Table 1. The lattice parameter of the alloys was found to be slightly smaller than the milled alloy. This could be attributed to the second-phase (FeSb) formation. The formation of TiC and Cr_7C_3 during MA and its increase in volume fraction after SPS are well documented (Ref 24, 25). The absence of Ti leaves behind FeSb. This is greater in the 5-h BM-SPS samples owing to the greater volume fraction of TiC in the 5h BM-SPS samples (Table 6).

The SPS pellets at low magnification showed no porosity as observed in Figure S3 of supplementary data. The highmagnification BSE images of the SPS pellets are shown in Fig. 6. The overall composition of the sample was similar to the expected composition of the alloys. The microstructure revealed a major gray phase, whose composition is similar to that of the nominal alloy composition. In addition, small quantities of black and white regions were observed in the microstructure. The black region is rich in Ti and corresponds to TiC but could not be quantified with precision owing to limitations in the detection of Carbon from EDS. For the sake of brevity, the composition from two black regions in TiFe_{0.5}Ni_{0.5}Sb is shown in Figure S4 of supplementary data. It is worth noting that owing to the fine size of the grain and the interaction volume effect, the EDS data exhibit certain fraction of the other elements too. Our previous report has established the TiC formation during BM-SPS of HH alloys (Ref 27). The white region that is rich in Fe and Sb is found to be distributed along the particle boundaries in the sample. This could be attributed to the higher diffusivity of the white region for it being rich in Sb, which has a lower melting point. In the Sbrich side of the Fe-Sb binary phase diagram, there is a presence of a line compound FeSb₂ which has a peritectic temperature of 1011 K (Ref 29). All the alloys have slightly higher concentration of Sb in comparison with Fe. The 5-h BM-SPS samples retained their nanocrystallinity as shown in Figure S5 of supplementary data.

Table 2	SEM-EDS	compositional	analysis i	n TiFe _{0.}	₅ Ni _{0.5} Sb ₁	_ _x Sn _x	as-cast	pellets	(N=3)	ļ
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			Element				
Alloy	Phase	Ti	Fe	Ni	Sb	Sn	
TiFe _{0.5} Ni _{0.5} Sb	Expected	33.3	16.6	16.6	33.3	0	
	Overall	33.6 ± 0.1	$18.4{\pm}0.1$	17.2 ± 0.1	30.7 ± 0.1	0	
	Grey (1)	33.4 ± 0.2	16.5 ± 0.2	$18.8 {\pm} 0.3$	31.2 ± 0.3	0	
	White (2)	40.6 ± 1.2	8.3 ± 0.7	11.2 ± 1.4	39.9 ± 0.9	0	
	Black (3)	86.7±1.2	2.3 ± 0.3	5.2 ± 0.6	5.8 ± 0.9	0	
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	Expected	33.3	16.6	16.6	31.3	1.7	
	Overall	$34.4{\pm}0.3$	17.8 ± 0.4	17.1 ± 0.2	29.1±0.1	1.7 ± 0.1	
	Grey (1)	34.2 ± 0.1	16.6 ± 0.8	18.3 ± 0.3	29.4 ± 0.2	1.5 ± 0.3	
	White (2)	$8.0{\pm}0.7$	50.0 ± 1.7	1.2 ± 0.7	26.3 ± 0.1	14.4 ± 0.2	
	Black (3)	75.9 ± 2.9	12.2 ± 0.9	$0.2{\pm}0.0$	11.6 ± 0.8	2.2±1.2	
TiFe _{0.5} Ni _{0.5} Sb _{0.9} Sn _{0.1}	Expected	33.3	16.6	16.6	30	3.3	
	Overall	34.0 ± 0.4	17.8 ± 0.4	17.0 ± 0.3	28.0 ± 0.1	3.2 ± 0.5	
	Grey (1)	35.3 ± 0.4	15.6 ± 0.9	16.9 ± 0.7	29.0 ± 0.2	3.2 ± 0.2	
	White (2)	34.7±3.1	29.6 ± 4.4	2.2 ± 0.9	30.6 ± 2.3	4.5 ± 0.5	
	Black (3)	95.1±2.3	1.8 ± 0.9	$0.2{\pm}0.0$	$0.7{\pm}0.2$	$2.2{\pm}1.0$	
TiFe _{0.5} Ni _{0.5} Sb _{0.8} Sn _{0.2}	Expected	33.3	16.6	16.6	26.7	6.6	
	Overall	34.0 ± 0.1	18.1 ± 0.2	$17.8 {\pm} 0.0$	24.3 ± 0.2	5.9 ± 0.3	
	Grey (1)	33.9 ± 0.8	14.7 ± 0.1	21.1±0.5	25.8 ± 0.4	4.5 ± 0.1	
	White (2)	36.5 ± 0.9	24.3±3.1	4.5 ± 2.1	26.1 ± 2.7	8.6 ± 2.6	
	Black (3)	79.1±0.0	5.1±0.1	5.7±0.4	8.6±0.1	1.6 ± 0.1	



Fig. 3 XRD patterns of 1h (a) BM alloys, (b) BM-SPS TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x alloys

3.4 Transport Properties of 1h BM-SPS Samples

The Seebeck coefficient as a function of temperature for the 1-h BM-SPS samples are displayed in Fig. 7(a). The S value for the pristine sample is negative at every temperature. This indicates that the alloy is an n-type semiconductor. Although the band structure of TiFe_{0.5}Ni_{0.5}Sb predicts the sample to have the E_f at the center of the band gap, minor variations in Fe and Ni content can shift the E_f closer to the valence band or conduction band respectively (Ref 21). As can be observed from Table 3, all the samples exhibited a slight excess of Ni in comparison to Fe. The n-type character in all the samples except x = 0.2 alloy corroborates with that predicted in literature of Ni excess TiFe_{0.5}Ni_{0.5}Sb alloys exhibiting n-type

semiconducting behavior. Additionally, the Seebeck coefficient of the pristine sample obtained at room temperature is lower than the reported value (Ref 21). It is also lower than that reported for TiCoSb (Ref 13).The lower values can be attributed to minor compositional variation by way of (1) loss of Sb, (2) presence of Fe-Sb-type secondary phase, and (3) TiC as a secondary phase. The loss of Sb has been reported to alter the thermoelectric properties in similar materials (Ref 30). The change in polarity in the Seebeck coefficient value has been reported in the literature and has been attributed to a change in stoichiometry and reduced structural disorder (Ref 12, 13). Additionally, there is a slight difference in the composition of the x = 0.2 alloy and the white region is rich in Fe, Sn and Sb in this alloy. This could also be a reason for x = 0.2 alloy to be



Fig. 4 SEM micrographs of 1h BM-SPS pellets at high magnification showing second phase (white) in (a) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.05}$, (b) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.05}$, (c) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.2}$

			Element				
Alloy	Phase	Ti	Fe	Ni	Sb	Sn	
TiFe _{0.5} Ni _{0.5} Sb	Expected	33.3	16.6	16.6	33.3	0	
	Overall	33.9 ± 0.2	17.6 ± 0.2	15.8 ± 0.1	32.9 ± 0.1	0	
	Grey	33.3 ± 0.3	16.2 ± 0.1	18.0 ± 0.1	32.5 ± 0.3	0	
	White	21.3±0.3	26.5 ± 0.2	15.1±0.2	37.1±0.1	0	
	Black	59.8 ± 0.4	10.2 ± 0.2	9.5 ± 0.7	20.5 ± 0.3	0	
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	Expected	33.3	16.6	16.6	31.3	1.7	
	Overall	33.6 ± 0.3	17.3 ± 0.3	15.9 ± 0.3	31.0 ± 0.1	2.3 ± 0.2	
	Grey	33.7±0.3	15.4 ± 0.4	$18.4{\pm}0.4$	30.9 ± 0.1	1.5 ± 0.1	
	White	17.5 ± 1.1	28.6 ± 0.3	13.3 ± 0.9	31.6 ± 1.5	9.0±1.6	
	Black	54.7±0.9	12.0 ± 0.6	$9.8 {\pm} 0.1$	21.0 ± 0.2	2.5 ± 0.2	
$TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}$	Expected	33.3	16.6	16.6	30	3.3	
	Overall	33.5 ± 0.2	17.1 ± 0.2	16.1 ± 0.1	29.9 ± 0.1	$3.4{\pm}0.1$	
	Grey	33.4±0.5	15.3±1.0	18.6 ± 0.9	30.3 ± 0.9	$2.4{\pm}0.9$	
	White	21.5 ± 1.2	$25.4{\pm}1.0$	14.4 ± 0.5	29.6 ± 0.7	9.2±1.3	
	Black	75.9 ± 2.2	5.9 ± 0.6	5.7 ± 0.6	11.2 ± 0.9	1.3 ± 0.1	
TiFe _{0.5} Ni _{0.5} Sb _{0.8} Sn _{0.2}	Expected	33.3	16.6	16.6	26.7	6.6	
	Overall	33.0 ± 0.2	17.5 ± 0.1	16.4 ± 0.2	26.6 ± 0.3	6.5 ± 0.1	
	Grey	33.3±0.2	15.1±0.6	18.9 ± 0.5	27.6 ± 0.4	5.1±0.3	
	White	6.2 ± 1.2	47.8 ± 2.0	8.7±0.5	13.7±0.9	23.6±1.1	
	Black	37.9±1.2	23.8±0.7	9.8±0.4	17.0±0.8	11.5±0.5	

Table 3 SEM-EDS compositional analysis in TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x 1h BM-SPS pellets (N=3)



Fig. 5 XRD patterns of 5h (a) BM alloys, (b) BM-SPS $TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x$ alloys

Table 4 Crystallite size of the alloys based on processing conditio	Table 4	Crystallite si	ze of the allovs	based on	processing conditions	
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	Crystallite size (in n	nm) of half-Heusler phase
Alloy	5h BM	5h BM-SPS
TiFe _{0.5} Ni _{0.5} Sb	23±2	28±3
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	29±3	35±4
$TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}$	29±2	38±3
$TiFe_{0.5}Ni_{0.5}Sb_{0.8}Sn_{0.2}$	30±1	40±2

			Element				
Alloy	Phase	Ti	Fe	Ni	Sb	Sn	
TiFe _{0.5} Ni _{0.5} Sb	Expected	33.3	16.6	16.6	33.3	0	
	Overall	36.1±0.5	16.9 ± 0.2	15.6 ± 0.1	31.4±0.2	0	
	Grey	33.5 ± 0.3	15.6 ± 0.2	18.2 ± 0.4	32.6 ± 0.8	0	
	White	$20.4{\pm}1.0$	25.6±1.5	16.2 ± 1.2	$37.8 {\pm} 0.6$	0	
	Black	88.5±2.4	2.5 ± 0.8	2.2 ± 0.6	6.7 ± 1.1	0	
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	Expected	33.3	16.6	16.6	31.3	1.7	
0.5 0.5 0.75 0.05	Overall	36.4 ± 0.1	16.4 ± 0.1	15.6 ± 0.1	$29.8 {\pm} 0.3$	1.9 ± 0.1	
	Grey	34.1 ± 0.9	15.4 ± 0.5	18.3 ± 0.1	31.1 ± 0.4	$1.4{\pm}0.7$	
	White	12.9 ± 0.6	27.1 ± 0.1	17.5 ± 0.8	$38.0 {\pm} 0.8$	5.0±0.7	
	Black	46.1±2.3	13.4 ± 0.7	13.0 ± 0.5	25.7 ± 0.7	1.8 ± 0.4	
$TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}$	Expected	33.3	16.6	16.6	30	3.3	
	Overall	36.2 ± 0.8	16.6 ± 0.3	15.4 ± 0.2	28.7 ± 0.6	3.1±0.5	
	Grey	31.9 ± 0.2	15.4 ± 0.1	19.5 ± 0.6	30.4 ± 0.3	2.8 ± 0.2	
	White	14.8 ± 0.1	29.5 ± 0.7	15.6 ± 0.1	31.2 ± 1.4	9.0±2.1	
	Black	67.8 ± 2.1	$9.6 {\pm} 0.5$	7.3 ± 0.4	9.5 ± 0.7	5.8 ± 0.6	
$TiFe_{0.5}Ni_{0.5}Sb_{0.8}Sn_{0.2}$	Expected	33.3	16.6	16.6	26.7	6.6	
0.5 0.5 0.6 0.2	Overall	36.6 ± 0.3	16.4 ± 0.1	15.5 ± 0.3	26.7 ± 0.2	4.8±0.3	
	Grey	33.3±1.9	15.6 ± 0.4	18.2 ± 1.7	29.1±1.7	3.7±1.2	
	White	32.9 ± 0.4	19.2 ± 0.4	14.8 ± 0.6	$24.4{\pm}1.0$	8.7±1.7	
	Black	76.1±2.2	$5.6 {\pm} 0.4$	$5.9 {\pm} 0.6$	10.6 ± 1.0	1.9±0.2	

Table 5	SEM-EDS	compositional	analysis in	TiFe _{0.5} Ni ₀	5Sb _{1-x} Sn _x	5h	BM-SPS	pellets	(N =	= 3)
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Table 6 Image analysis of SPS pellets showing volume fraction of white phase (N = 5)

	White	region	Black	region
Alloy	1h BM-SPS	5h BM-SPS	1h BM-SPS	5h BM-SPS
TiFe _{0.5} Ni _{0.5} Sb	2.2±0.5	3.1±0.3	$1.7{\pm}0.2$	3.6±0.1
TiFe _{0.5} Ni _{0.5} Sb _{0.95} Sn _{0.05}	2.2 ± 0.3	$5.1 \pm 0.1.4.1$	1.8 ± 0.3	4.1 ± 0.1
TiFe _{0.5} Ni _{0.5} Sb _{0.9} Sn _{0.1}	$2.9{\pm}0.2$	5.5 ± 0.4	2.1 ± 0.3	4.5±0.1
TiFe _{0.5} Ni _{0.5} Sb _{0.8} Sn _{0.2}	$4.8 {\pm} 0.1$	$6.2{\pm}0.8$	$2.7{\pm}0.4$	5.9 ± 0.2



Fig. 6 SEM micrographs of 5h BM-SPS pellets at high magnification showing second phase (white) in (a) $TiFe_{0.5}Ni_{0.5}Sb$, (b) $TiFe_{0.5}Ni_{0.5}Sb_{0.95}Sn_{0.05}$, (c) $TiFe_{0.5}Ni_{0.5}Sb_{0.9}Sn_{0.1}$ and (d) $TiFe_{0.5}Ni_{0.5}Sb_{0.8}Sn_{0.2}$

exhibiting a change in polarity to become a p-type semiconductor.

The electrical conductivity of the pristine sample is the least across all range of temperature of measurement as shown in Fig. 7(b). The conductivity increases with temperature for all the samples. This is a trend observed commonly in non-degenerate semiconductors. The change in slope increases progressively with increasing Sn content. This can be attributed to the increase in metallic character in the alloys. In the case of Sn-doped samples, there is an abrupt transition in electrical conductivity in the temperature range of 550-750 K. The sudden change in conductivity value in the heating cycle can be attributed to the presence of the secondary phase (Table 3). This is because the half-Heusler phase is stable up to its melting point. In order to confirm the effect of the secondary white region on this sudden increase, DTA studies were carried out for the x = 0.05 and x = 0.2 samples as shown in Figure S6 of

supplementary data. Endothermic peak with an onset temperature of 643 and 694 K was observed in the case of x = 0.05and x = 0.2 alloys, respectively. However, the nature of phase transformation that is responsible for this is hard to decipher. This is because the low-volume fraction of secondary white region goes undetected in XRD. However, it is worth noting that although the phase goes undetected in XRD, the white phase could be established using EDS. Similar transition in electrical conductivity has been reported in Sn-doped TiCoSb. This is attributed to the presence of CoSb which is present as a secondary phase (Ref 18).

The power factor of the pristine sample reached 0.056 mWm⁻¹ K⁻² at 737 K as shown in Fig. 7(c). With increasing Sn content, there was decrease in the power factor. This is because the decrease in S value dominates over the increase in the κ value. Owing to higher Seebeck coefficient in the heating



Fig. 7 (a) Seebeck coefficient, (b) electrical conductivity and (c) power factor of 1h BM-SPS TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x

cycle of the samples, the net power factor in the heating cycle is greater than in the cooling cycle.

The total thermal conductivity of all the alloys exhibit Umklapp type of scattering as shown in Fig. 8(a). The κ decreases with the increase in temperature for all the alloys. The κ for TiCoSb is reported to be 24 Wm⁻¹ K⁻¹at 350 K (Ref 13). The k of the pristine sample is, however, much higher (9.2 $Wm^{-1} K^{-1}$) than that reported by Balke *et al.* (4 $Wm^{-1} K^{-1}$) (Ref 21). Additionally, with increasing Sn concentration there was an increase in the κ of all the samples which was contrary to that reported earlier (Ref 13). In order to see the contribution of the electronic (κ_e) and lattice (κ_l) towards κ , they were calculated for all the samples. The Lorenz number (L) has been calculated by considering acoustic phonon scattering model as reported before (Ref 31). The room temperature κ_e values are demonstrated in Figure 8(b). The κ_e for all the samples is <0.1 $Wm^{-1} K^{-1}$ at 350 K. The κ_e is in the range of 0.25-0.45 $Wm^{-1} K^{-1}$ at 873 K for all the samples which is slightly higher than that reported for TiCoSb (Ref 13). The κ_e contributes less than 10% to κ . Thus, the major contribution to κ is due to κ_1 as demonstrated in Fig. 8(c). Owing to the grain size being large in the 1h BM-SPS pellets, the κ_1 is high for all the samples. Increase in Sn concentration leads to increased volume fraction

of secondary phases which in turn leads to an increase in κ_1 and κ . FeSb₂ and TiC are both known to have high κ value with TiC known to exhibit increase in κ value with the increase in temperature (Ref 32, 33).

The plot of ZT as a function of increasing temperature is displayed in Fig. 8(d). The pristine sample exhibits a maximum ZT of 0.0078 at 873 K. With increasing Sn concentration, there is a simultaneous decrease in power factor and thermal conductivity. This in turn leads to a monotonic decrease in the ZT value with increasing Sn concentration. This value is, however, higher than that reported by Balke *et al.* at 400 K for the pristine sample (Ref 21).

3.5 Transport Properties of 5h BM-SPS Samples

The Seebeck coefficient as a function of temperature is displayed in Fig. 9(a). There is an increase in Seebeck coefficient for all the samples with increasing temperature. The Seebeck coefficient for all the samples is lower than the 1h BM-SPS samples. This can be attributed to the increased volume fraction of the secondary phases (Table 6). The Seebeck coefficient decreases with increasing Sn concentration. This can be attributed to the increase in secondary phase formation as shown in Fig. 6 and Table 6. However, the exact composition of



Fig. 8 (a) Total thermal conductivity, (b) electronic thermal conductivity, (c) lattice thermal conductivity and (d) ZT in 1h BM-SPS $TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x$

the secondary white region could not be determined. As the size of the secondary phases are small (<1 μ m), EDS analysis could not give the exact composition of the phase owing to the beam diameter being of similar dimension. However, looking at the BSE micrograph closely, the secondary phase (white) appears to be brighter than the matrix which is grey in color. Thus, it can be assumed that the white region is richer in higher atomic number element, most notably Sb and Sn. However, since there is presence of white region even in the pristine sample, placing the argument of the secondary phase being rich in Sb will not be a wrong assumption. The arguments hold well because in all the compositions, the secondary white region is rich in Sb. It is worth noting that due to inoculation of a greater fraction of secondary phases, the trend of p-type character shown in the x = 0.2 alloy in the 1h BM-SPS alloy is not observed for the 5h BM-SPS alloy.

The electrical conductivity as a function of temperature is as displayed in Fig. 9(b). The conductivity value increases with increasing temperature for all the alloys. This implies that the samples are non-degenerate semiconductors. However, the slope change is higher as compared to 1h BM-SPS implying

that the samples are more metallic than the 1h BM-SPS alloys. This is supported by the fact that electrical conductivity of the 5h BM-SPS alloys is one order higher than the 1h BM-SPS alloys. The 5h BM-SPS alloys in addition to the white region has large volume fraction of black region which was found to be TiC (Fig. 6). TiC has an electrical conductivity of $4.7 \times 10^{5} \text{Sm}^{-1}$ at room temperature. This is one order higher in magnitude than the 1h BM-SPS alloys. This aids in the increase in the electrical conductivity for the 5h BM-SPS alloys. The x = 0.2 sample exhibits the minimum electrical conductivity among all the alloys. This can be attributed to the increased volume fraction of secondary phases that leads to charge carrier scattering. The presence of a spike in the electrical conductivity plot for x = 0.05 and x = 0.1 alloys was observed for the same reason as explained in the 1h BM-SPS alloys.

Although the Seebeck coefficient of the samples is lower, the electrical conductivity of the samples being higher leads to power factor values to be similar in the 5h BM-SPS pellets to the 1h BM-SPS pellets. The overall power factor of the samples decreases with the increase in Sn concentration. A maximum



Fig. 9 (a) Seebeck coefficient, (b) electrical conductivity and (c) power factor of 5h BM-SPS $TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x$

power factor of 0.063 mWm⁻¹Ks⁻² at 880 K was obtained for the pristine sample.

The κ as a function of temperature is displayed in Fig. 10(a). There is a slight increase in κ with increasing temperature. Unlike in the case of 1h BM-SPS alloys, these alloys do not show Umklapp type of scattering. The κ of the x = 0.2 alloy is the largest owing to the presence of a greater volume fraction of TiC. In order to study the contribution of the individual components toward κ , κ_e and κ_l were calculated as shown in Fig. 10(b) and (c), respectively. Owing to the rise in the electrical conductivity value as compared to the 1h BM-SPS pellets, there is an increase in the κ_e in comparison with the 1h BM-SPS pellets. The x = 0.2 alloy shows the lowest κ_e across all temperature and is expected owing to it having the lowest electrical conductivity. The room temperature κ_1 of all the samples is lower than the 1h BM-SPS pellets. The 5h BM-SPS pellets are finer in size. This leads to phonon scattering brought about by nanostructuring in the alloys. The κ_1 is again the major contributor to the κ in all these alloys. The pristine sample exhibits a maximum ZT = 0.0078 at 873 K. Due to reduced power factor and increased thermal conductivity upon increasing the Sn content, no improvement in ZT value was observed.

4. Conclusions

The present work looks into the effect of processing routes on the thermoelectric properties of TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x. Vacuum arc melting followed by 1h BM-SPS gave rise to alloys with finer grain size and reduced volume fraction of secondary phases. However, 5h BM-SPS gave rise to increased volume fraction of secondary phases. The power factor of the pristine sample is 0.056 and $0.063 \text{ mWm}^{-1} \text{ K}^{-2}$ for the 1h and 5h BM-SPS samples at 873 K. Substitution of Sn in the Sb center led to the decrease in the thermoelectric property due to combined drop in S and rise in κ values. The presence of Sn in the white region confirms that certain Sn goes into the secondary phases and thus complete Sn solubility is not observed after SPS. Furthermore, other than the 20% Sn-doped 1h BM-SPS sample, Sn doping did not bring forth p-type activity in any other alloy. A maximum ZT of 0.0078 at 873 K was obtained for the 1h BM-SPS and 5h BM-SPS undoped samples.



Fig. 10 (a) Total thermal conductivity, (b) electronic thermal conductivity, (c) lattice thermal conductivity and (d) ZT in 5h BM-SPS $TiFe_{0.5}Ni_{0.5}Sb_{1-x}Sn_x$

Conflict of interest

The authors declare that they have no conflict of interest.

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